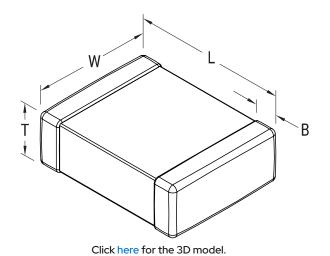


## CBR02C849C3GAC

Specifications

CBR-SMD RF COG, Ceramic, 8.4 pF, +/-0.25 pF, 25 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0201



General Information	
Series	CBR-SMD RF COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	0.3 mg
Notes	Solder Reflow Only.
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0201
L	0.6mm +/-0.03mm
W	0.3mm +/-0.03mm
т	0.3mm +/-0.03mm
В	0.15mm +/-0.05mm

15000

T&R, 180mm, Plastic Tape

Packaging Specifications	
Packaging	

Packaging Quantity

8.4 pF Capacitance +/-0.25 pF Tolerance Voltage DC 25 VDC **Dielectric Withstanding Voltage** 62.5 VDC -55/+125°C **Temperature Range** Temp. Coefficient COG 0.176% **Dissipation Factor** 0% Loss/Decade Hour Aging Rate Insulation Resistance 10 GOhms **Quality Factor** 568

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.